74HC4052-Q100; 74HCT4052-Q100

Dual 4-channel analog multiplexer/demultiplexer Rev. 2 — 22 November 2012 Pro

Product data sheet

General description

The 74HC4052-Q100; 74HCT4052-Q100 is a high-speed Si-gate CMOS device and is pin compatible with Low-power Schottky TTL (LSTTL). The device is specified in compliance with JEDEC standard no. 7A.

The 74HC4052-Q100; 74HCT4052-Q100 is a dual 4-channel analog multiplexer/demultiplexer with common select logic. Each multiplexer has four independent inputs/outputs (pins nY0 to nY3) and a common input/output (pin nZ). The common channel select logics include two digital select inputs (pins S0 and S1) and an active LOW enable input (pin \overline{E}). When pin \overline{E} = LOW, one of the four switches is selected (low-impedance ON-state) with pins S0 and S1. When pin E = HIGH, all switches are in the high-impedance OFF-state, independent of pins S0 and S1.

 V_{CC} and GND are the supply voltage pins for the digital control inputs (pins S0, S1 and \overline{E}). The V_{CC} to GND ranges are 2.0 V to 10.0 V for the 74HC4052-Q100, and 4.5 V to 5.5 V for the 74HCT4052-Q100. The analog inputs/outputs (pins nY0 to nY3 and nZ) can swing between V_{CC} as a positive limit and V_{EE} as a negative limit. $V_{CC} - V_{EE}$ may not exceed 10.0 V. For operation as a digital multiplexer/demultiplexer, V_{EE} is connected to GND (typically ground).

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - ◆ Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Wide analog input voltage range from -5 V to +5 V
- Low ON resistance:
 - ♦ 80 Ω (typical) at $V_{CC} V_{EE} = 4.5 \text{ V}$
 - 70 Ω (typical) at V_{CC} − V_{EE} = 6.0 V
 - 60 Ω (typical) at $V_{CC} V_{EE} = 9.0 \text{ V}$
- Logic level translation: to enable 5 V logic to communicate with ±5 V analog signals
- Typical 'break before make' built-in
- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F exceeds 2000 V
 - ♦ MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
 - CDM AEC-Q100-011 revision B exceeds 1000 V
- Multiple package options



3. Applications

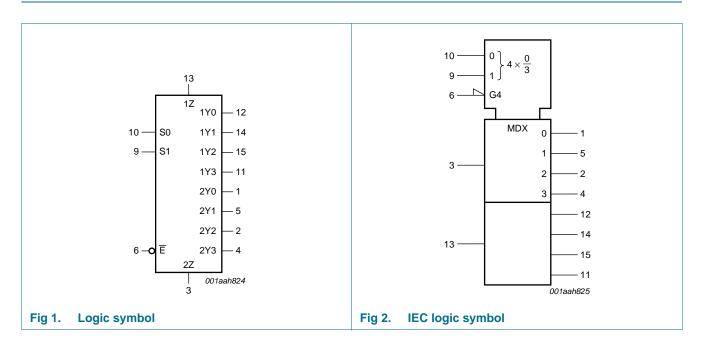
- Analog multiplexing and demultiplexing
- Digital multiplexing and demultiplexing
- Signal gating

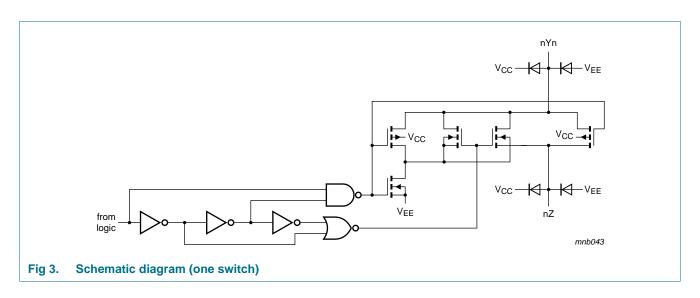
4. Ordering information

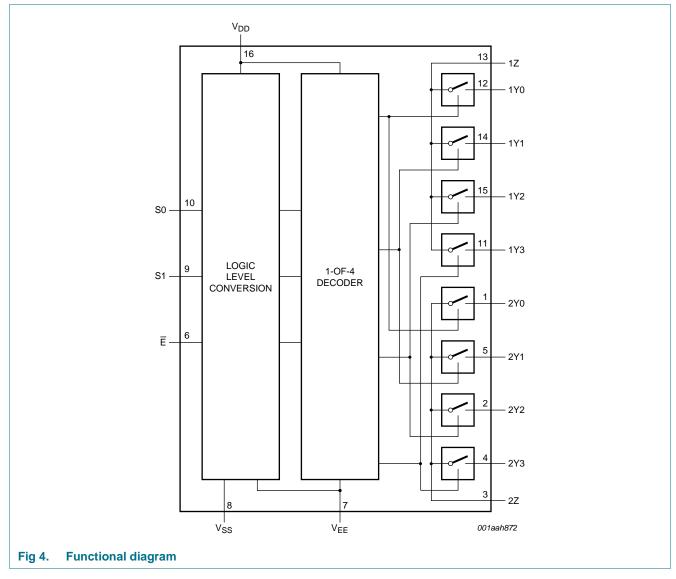
Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74HC4052D-Q100	-40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body	SOT109-1
74HCT4052D-Q100			width 3.9 mm	
74HC4052PW-Q100	−40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads;	SOT403-1
74HCT4052PW-Q100			body width 4.4 mm	
74HC4052BQ-Q100	–40 °C to +125 °C	DHVQFN16	plastic dual-in line compatible thermal enhanced	SOT763-1
74HCT4052BQ-Q100			very thin quad flat package; no leads; 16 terminals; body 2.5 \times 3.5 \times 0.85 mm	

5. Functional diagram

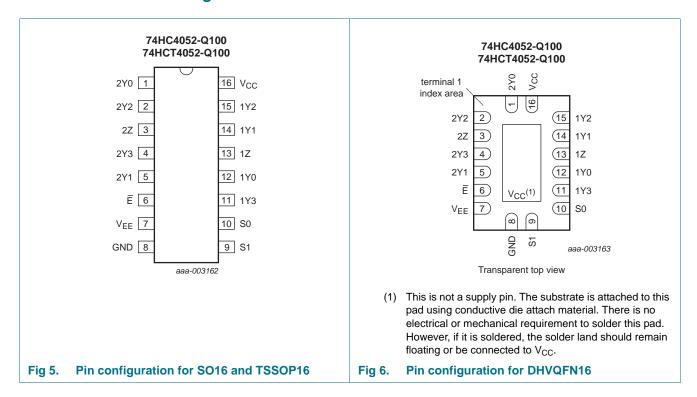






6. Pinning information

6.1 Pinning



6.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
2Y0, 2Y1, 2Y2, 2Y3	1, 5, 2, 4	independent input or output
1Z, 2Z	13, 3	common input or output
Ē	6	enable input (active LOW)
V _{EE}	7	negative supply voltage
GND	8	ground (0 V)
S0, S1	10, 9	select logic input
1Y0, 1Y1, 1Y2, 1Y3	12, 14, 15, 11	independent input or output
V _{CC}	16	positive supply voltage

7. Functional description

7.1 Function table

Table 3. Function table [1]

Input			Channel on
Ē	S1	S0	
L	L	L	nY0 and nZ
L	L	Н	nY1 and nZ
L	Н	L	nY2 and nZ
L	Н	Н	nY3 and nZ
Н	X	X	none

^[1] H = HIGH voltage level; L = LOW voltage level; X = don't care.

8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to $V_{EE} = GND$ (ground = 0 V).

•					
Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		[<u>1]</u> -0.5	+11.0	V
I _{IK}	input clamping current	$V_I < -0.5 \text{ V or } V_I > V_{CC} + 0.5 \text{ V}$	-	±20	mA
I _{SK}	switch clamping current	$V_{SW} < -0.5 \ V$ or $V_{SW} > V_{CC}$ + $0.5 \ V$	-	±20	mA
I _{SW}	switch current	$-0.5 \text{ V} < \text{V}_{\text{SW}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$	-	±25	mA
I _{EE}	supply current		-	±20	mA
I _{CC}	supply current		-	50	mA
I_{GND}	ground current		-	-50	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation		[2] _	500	mW
Р	power dissipation	per switch	-	100	mW

^[1] To avoid drawing V_{CC} current out of pins nZ, when switch current flows in pins nYn, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into pins nZ, no V_{CC} current flows out of pins nYn. In this case there is no limit for the voltage drop across the switch, but the voltages at pins nYn and nZ may not exceed V_{CC} or V_{EE}.

^[2] For SO16 packages: above 70 °C the value of P_{tot} derates linearly with 8 mW/K. For TSSOP16 package: above 60 °C the value of P_{tot} derates linearly with 5.5 mW/K. For DHVQFN16 package: above 60 °C the value of P_{tot} derates linearly with 4.5 mW/K.

9. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	74H	C4052-0	Q100	74H0	CT4052-	Q100	Unit
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage	see <u>Figure 7</u> and <u>Figure 8</u>						•	
		V _{CC} – GND	2.0	5.0	10.0	4.5	5.0	5.5	V
		$V_{CC} - V_{EE}$	2.0	5.0	10.0	2.0	5.0	10.0	V
V_{I}	input voltage		GND	-	V_{CC}	GND	-	V_{CC}	V
V_{SW}	switch voltage		V_{EE}	-	V_{CC}	V_{EE}	-	V_{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
$\Delta t/\Delta V$	input transition rise and fall	$V_{CC} = 2.0 \text{ V}$	-	-	625	-	-	-	ns/V
	rate	$V_{CC} = 4.5 \text{ V}$	-	1.67	139	-	1.67	139	ns/V
		$V_{CC} = 6.0 \text{ V}$	-	-	83	-	-	-	ns/V
		$V_{CC} = 10.0 \text{ V}$	-	-	31	-	-	-	ns/V

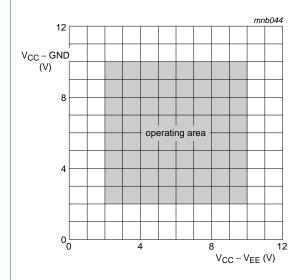


Fig 7. Guaranteed operating area as a function of the supply voltages for 74HC4052-Q100

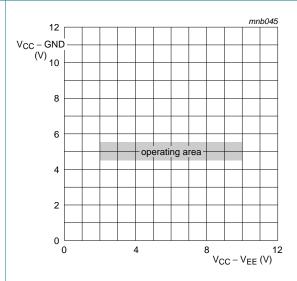


Fig 8. Guaranteed operating area as a function of the supply voltages for 74HCT4052-Q100

10. Static characteristics

R_{ON} resistance per switch for 74HC405-Q100 and 74HCT4052-Q100 Table 6.

 $V_I = V_{IH}$ or V_{IL} ; for test circuit see <u>Figure 9</u>.

 V_{is} is the input voltage at a nYn or nZ terminal, whichever is assigned as an input.

 V_{os} is the output voltage at a nYn or nZ terminal, whichever is assigned as an output.

For 74HC4052-Q100: V_{CC} – GND or V_{CC} – V_{EE} = 2.0 V, 4.5 V, 6.0 V and 9.0 V. For 74HCT4052-Q100: V_{CC} – GND = 4.5 V and 5.5 V, V_{CC} – V_{EE} = 2.0 V, 4.5 V, 6.0 V and 9.0 V.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = -4	0 °C to +85 °C[1]					
R _{ON(peak)}	ON resistance (peak)	$V_{is} = V_{CC}$ to V_{EE}				
		V_{CC} = 2.0 V; V_{EE} = 0 V; I_{SW} = 100 μA	[2] _	-	-	Ω
		V_{CC} = 4.5 V; V_{EE} = 0 V; I_{SW} = 1000 μA	-	100	225	Ω
		V_{CC} = 6.0 V; V_{EE} = 0 V; I_{SW} = 1000 μA	-	90	200	Ω
		$V_{CC} = 4.5 \text{ V}; V_{EE} = -4.5 \text{ V}; I_{SW} = 1000 \mu\text{A}$	-	70	165	Ω
R _{ON(rail)}	ON resistance (rail)	$V_{is} = V_{EE}$				
		V_{CC} = 2.0 V; V_{EE} = 0 V; I_{SW} = 100 μA	[2] _	150	-	Ω
		V_{CC} = 4.5 V; V_{EE} = 0 V; I_{SW} = 1000 μA	-	80	175	Ω
		V_{CC} = 6.0 V; V_{EE} = 0 V; I_{SW} = 1000 μA	-	70	150	Ω
		V_{CC} = 4.5 V; V_{EE} = -4.5 V; I_{SW} = 1000 μA	-	60	130	Ω
		$V_{is} = V_{CC}$				
		V_{CC} = 2.0 V; V_{EE} = 0 V; I_{SW} = 100 μA	[2] _	150	-	Ω
		V_{CC} = 4.5 V; V_{EE} = 0 V; I_{SW} = 1000 μA	-	90	200	Ω
		V_{CC} = 6.0 V; V_{EE} = 0 V; I_{SW} = 1000 μA	-	80	175	Ω
		V_{CC} = 4.5 V; V_{EE} = -4.5 V; I_{SW} = 1000 μA	-	65	150	Ω
ΔR_{ON}	ON resistance mismatch	$V_{is} = V_{CC}$ to V_{EE}				
	between channels	$V_{CC} = 2.0 \text{ V}; V_{EE} = 0 \text{ V}$	[2] _	-	-	Ω
		$V_{CC} = 4.5 \text{ V}; V_{EE} = 0 \text{ V}$	-	9	-	Ω
		$V_{CC} = 6.0 \text{ V}; V_{EE} = 0 \text{ V}$	-	8	-	Ω
		$V_{CC} = 4.5 \text{ V}; V_{EE} = -4.5 \text{ V}$	-	6	-	Ω
$T_{amb} = -4$	0 °C to +125 °C					
R _{ON(peak)}	ON resistance (peak)	$V_{is} = V_{CC}$ to V_{EE}				
		V_{CC} = 2.0 V; V_{EE} = 0 V; I_{SW} = 100 μA	[2] _	-	-	Ω
		V_{CC} = 4.5 V; V_{EE} = 0 V; I_{SW} = 1000 μA	-	-	270	Ω
		V_{CC} = 6.0 V; V_{EE} = 0 V; I_{SW} = 1000 μA	-	-	240	Ω
		$V_{CC} = 4.5 \text{ V}; V_{EE} = -4.5 \text{ V}; I_{SW} = 1000 \mu\text{A}$	-	-	195	Ω

Table 6. R_{ON} resistance per switch for 74HC405-Q100 and 74HCT4052-Q100 ...continued

 $V_I = V_{IH}$ or V_{IL} ; for test circuit see Figure 9.

 V_{is} is the input voltage at a nYn or nZ terminal, whichever is assigned as an input.

Vos is the output voltage at a nYn or nZ terminal, whichever is assigned as an output.

For 74HC4052-Q100: V_{CC} – GND or V_{CC} – V_{EE} = 2.0 V, 4.5 V, 6.0 V and 9.0 V.

For 74HCT4052-Q100: V_{CC} – GND = 4.5 V and 5.5 V, V_{CC} – V_{FF} = 2.0 V, 4.5 V, 6.0 V and 9.0 V.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{ON(rail)}	ON resistance (rail)	$V_{is} = V_{EE}$				
		V_{CC} = 2.0 V; V_{EE} = 0 V; I_{SW} = 100 μA	[2] _	-	-	Ω
		V_{CC} = 4.5 V; V_{EE} = 0 V; I_{SW} = 1000 μA	-	-	210	Ω
		V_{CC} = 6.0 V; V_{EE} = 0 V; I_{SW} = 1000 μA	-	-	180	Ω
		V_{CC} = 4.5 V; V_{EE} = -4.5 V; I_{SW} = 1000 μA	-	-	160	Ω
		$V_{is} = V_{CC}$				
		V_{CC} = 2.0 V; V_{EE} = 0 V; I_{SW} = 100 μA	[2]	-	-	Ω
		V_{CC} = 4.5 V; V_{EE} = 0 V; I_{SW} = 1000 μA	-	-	240	Ω
		V_{CC} = 6.0 V; V_{EE} = 0 V; I_{SW} = 1000 μA	-	-	210	Ω
		$V_{CC} = 4.5 \text{ V}; V_{EE} = -4.5 \text{ V}; I_{SW} = 1000 \mu\text{A}$	-	-	180	Ω

- [1] All typical values are measured at T_{amb} = 25 °C.
- [2] When supply voltages (V_{CC} V_{EE}) near 2.0 V the analog switch ON resistance becomes extremely non-linear. When using a supply of 2 V, only use these devices for transmitting digital signals.

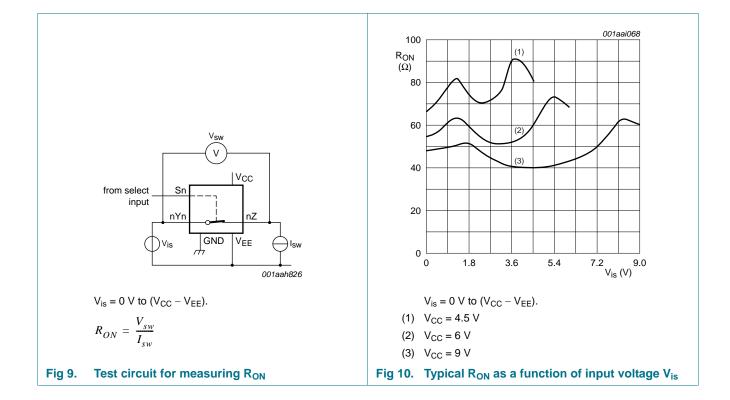


Table 7. Static characteristics for 74HC4052-Q100

Voltages are referenced to GND (ground = 0 V).

 V_{is} is the input voltage at pins nYn or nZ, whichever is assigned as an input.

Vos is the output voltage at pins nZ or nYn, whichever is assigned as an output.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = -4	0 °C to +85 °C[1]					
V_{IH}	HIGH-level input	V _{CC} = 2.0 V	1.5	1.2	-	V
	voltage	V _{CC} = 4.5 V	3.15	2.4	-	V
		V _{CC} = 6.0 V	4.2	3.2	-	V
		V _{CC} = 9.0 V	6.3	4.7	-	V
V _{IL}	LOW-level input	V _{CC} = 2.0 V	-	0.8	0.5	V
	voltage	V _{CC} = 4.5 V	-	2.1	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	V
		V _{CC} = 9.0 V	-	4.3	2.7	V
ı	input leakage current	$V_{EE} = 0 \text{ V}; V_I = V_{CC} \text{ or GND}$				
		V _{CC} = 6.0 V	-	-	±1.0	μΑ
		V _{CC} = 10.0 V	-	-	±2.0	μΑ
I _{S(OFF)}	OFF-state leakage current	V_{CC} = 10.0 V; V_{EE} = 0 V; V_{I} = V_{IH} or V_{IL} ; $ V_{SW} $ = V_{CC} - V_{EE} ; see Figure 11				
		per channel	-	-	±1.0	μΑ
		all channels	-	-	±2.0	μΑ
S(ON)	ON-state leakage current	$V_I = V_{IH}$ or V_{IL} ; $ V_{SW} = V_{CC} - V_{EE}$; $V_{CC} = 10.0$ V; $V_{EE} = 0$ V; see Figure 12	-	-	±2.0	μА
lcc	supply current	V_{EE} = 0 V; V_{I} = V_{CC} or GND; V_{is} = V_{EE} or V_{CC} ; V_{os} = V_{CC} or V_{EE}				
		V _{CC} = 6.0 V	-	-	80.0	μΑ
		V _{CC} = 10.0 V	-	-	160.0	μΑ
Cı	input capacitance		-	3.5	-	pF
C _{sw}	switch capacitance	independent pins nYn	-	5	-	pF
		common pins nZ	-	12	-	pF
Γ _{amb} = –4	0 °C to +125 °C					
√ _{IH}	HIGH-level input	V _{CC} = 2.0 V	1.5	-	-	V
	voltage	V _{CC} = 4.5 V	3.15	-	-	V
		V _{CC} = 6.0 V	4.2	-	-	V
		V _{CC} = 9.0 V	6.3	-	-	V
V _{IL}	LOW-level input	V _{CC} = 2.0 V	-	-	0.5	V
	voltage	V _{CC} = 4.5 V	-	-	1.35	V
		$V_{CC} = 6.0 \text{ V}$	-	-	1.8	V
		V _{CC} = 9.0 V	-	-	2.7	V
ı	input leakage current	$V_{EE} = 0 \text{ V}; V_I = V_{CC} \text{ or GND}$				
		V _{CC} = 6.0 V	-	-	±1.0	μΑ
		V _{CC} = 10.0 V	-	-	±2.0	μA

Table 7. Static characteristics for 74HC4052-Q100 ...continued

Voltages are referenced to GND (ground = 0 V).

 V_{is} is the input voltage at pins nYn or nZ, whichever is assigned as an input.

 V_{os} is the output voltage at pins nZ or nYn, whichever is assigned as an output.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{S(OFF)}	OFF-state leakage current	V_{CC} = 10.0 V; V_{EE} = 0 V; V_{I} = V_{IH} or V_{IL} ; $ V_{SW} $ = V_{CC} - V_{EE} ; see <u>Figure 11</u>				
		per channel	-	-	±1.0	μΑ
		all channels	-	-	±2.0	μΑ
I _{S(ON)}	ON-state leakage current	$V_I = V_{IH}$ or V_{IL} ; $ V_{SW} = V_{CC} - V_{EE}$; $V_{CC} = 10.0$ V; $V_{EE} = 0$ V; see Figure 12	-	-	±2.0	μА
I _{CC}	supply current	V_{EE} = 0 V; V_{I} = V_{CC} or GND; V_{is} = V_{EE} or V_{CC} ; V_{os} = V_{CC} or V_{EE}				
		V _{CC} = 6.0 V	-	-	160.0	μΑ
		V _{CC} = 10.0 V	-	-	320.0	μА

^[1] All typical values are measured at T_{amb} = 25 °C.

Table 8. Static characteristics for 74HCT4052-Q100

Voltages are referenced to GND (ground = 0 V).

 V_{is} is the input voltage at pins nYn or nZ, whichever is assigned as an input.

Vos is the output voltage at pins nZ or nYn, whichever is assigned as an output.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = -4	0 °C to +85 °C[1]					
V_{IH}	HIGH-level input voltage	V _{CC} = 4.5 V to 5.5 V	2.0	1.6	-	V
V_{IL}	LOW-level input voltage	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	-	1.2	0.8	V
I _I	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5$ V; $V_{EE} = 0$ V	-	-	±1.0	μΑ
I _{S(OFF)}	OFF-state leakage current	V_{CC} = 10.0 V; V_{EE} = 0 V; V_{I} = V_{IH} or V_{IL} ; $ V_{SW} $ = V_{CC} - V_{EE} ; see Figure 11				
		per channel	-	-	±1.0	μΑ
		all channels	-	-	±2.0	μΑ
I _{S(ON)}	ON-state leakage current	V_{CC} = 10.0 V; V_{EE} = 0 V; V_{I} = V_{IH} or V_{IL} ; $ V_{SW} $ = V_{CC} - V_{EE} ; see Figure 12	-	-	±2.0	μА
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $V_{is} = V_{EE}$ or V_{CC} ; $V_{os} = V_{CC}$ or V_{EE}				
		$V_{CC} = 5.5 \text{ V}; V_{EE} = 0 \text{ V}$	-	-	80.0	μΑ
		$V_{CC} = 5.0 \text{ V}; V_{EE} = -5.0 \text{ V}$	-	-	160.0	μΑ
ΔI_{CC}	additional supply current	per input; $V_I = V_{CC} - 2.1 \text{ V}$; other inputs at V_{CC} or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V; $V_{EE} = 0 \text{ V}$	-	45	202.5	μА
Cı	input capacitance		-	3.5	-	pF
C _{sw}	switch capacitance	independent pins nYn	-	5	-	pF
		common pins nZ	-	12	-	pF
T _{amb} = -4	0 °C to +125 °C					
V _{IH}	HIGH-level input voltage	V _{CC} = 4.5 V to 5.5 V	2.0	-	-	V

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Table 8. Static characteristics for 74HCT4052-Q100 ...continued

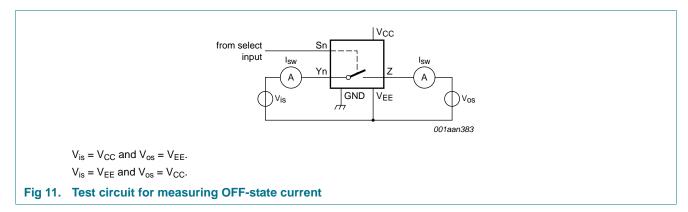
Voltages are referenced to GND (ground = 0 V).

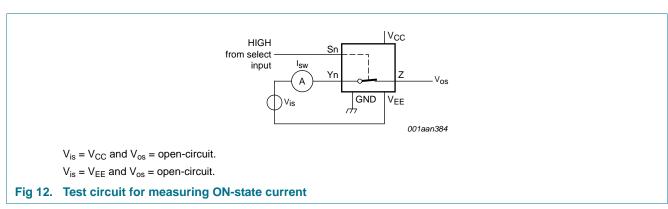
V_{is} is the input voltage at pins nYn or nZ, whichever is assigned as an input.

Vos is the output voltage at pins nZ or nYn, whichever is assigned as an output.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{IL}	LOW-level input voltage	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	-	-	0.8	V
I _I	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5$ V; $V_{EE} = 0$ V	-	-	±1.0	μΑ
I _{S(OFF)}	OFF-state leakage current	V_{CC} = 10.0 V; V_{EE} = 0 V; V_{I} = V_{IH} or V_{IL} ; $ V_{SW} $ = V_{CC} - V_{EE} ; see Figure 11				
		per channel	-	-	±1.0	μΑ
		all channels	-	-	±2.0	μΑ
I _{S(ON)}	ON-state leakage current	V_{CC} = 10.0 V; V_{EE} = 0 V; V_{I} = V_{IH} or V_{IL} ; $ V_{SW} $ = V_{CC} - V_{EE} ; see Figure 12	-	-	±2.0	μА
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $V_{is} = V_{EE}$ or V_{CC} ; $V_{os} = V_{CC}$ or V_{EE}				
		$V_{CC} = 5.5 \text{ V}; V_{EE} = 0 \text{ V}$	-	-	160.0	μΑ
		$V_{CC} = 5.0 \text{ V}; V_{EE} = -5.0 \text{ V}$	-	-	320.0	μΑ
ΔI_{CC}	additional supply current	per input; $V_I = V_{CC} - 2.1 \text{ V}$; other inputs at V_{CC} or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V; $V_{EE} = 0 \text{ V}$	-	-	220.5	μΑ

[1] All typical values are measured at $T_{amb} = 25$ °C.





11. Dynamic characteristics

Table 9. Dynamic characteristics for 74HC4052-Q100

GND = 0 V; $t_f = t_f = 6$ ns; $C_L = 50$ pF; for test circuit see <u>Figure 15</u>.

V_{is} is the input voltage at a nYn or nZ terminal, whichever is assigned as an input.

 V_{os} is the output voltage at a nYn or nZ terminal, whichever is assigned as an output.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$T_{amb} = -4$	0 °C to +85 °C[1]					
t _{pd}	propagation delay	V_{is} to V_{os} ; $R_L = \infty \Omega$; see <u>Figure 13</u>	[2]			
		$V_{CC} = 2.0 \text{ V}; V_{EE} = 0 \text{ V}$	-	14	75	ns
		$V_{CC} = 4.5 \text{ V}; V_{EE} = 0 \text{ V}$	-	5	15	ns
		V _{CC} = 6.0 V; V _{EE} = 0 V	-	4	13	ns
		$V_{CC} = 4.5 \text{ V}; V_{EE} = -4.5 \text{ V}$	-	4	10	ns
t _{on}	turn-on time	\overline{E} , Sn to V_{os} ; $R_{L} = \infty \ \Omega$; see Figure 14	<u>[3]</u>			
		V _{CC} = 2.0 V; V _{EE} = 0 V	-	105	405	ns
		V _{CC} = 4.5 V; V _{EE} = 0 V	-	38	81	ns
		$V_{CC} = 5.0 \text{ V}; V_{EE} = 0 \text{ V}; C_L = 15 \text{ pF}$	-	28	-	ns
		V _{CC} = 6.0 V; V _{EE} = 0 V	-	30	69	ns
		$V_{CC} = 4.5 \text{ V}; V_{EE} = -4.5 \text{ V}$	-	26	58	ns
t _{off}	turn-off time	\overline{E} , Sn to V _{os} ; R _L = 1 k Ω ; see Figure 14	<u>[4]</u>			
		V _{CC} = 2.0 V; V _{EE} = 0 V	-	74	315	ns
		V _{CC} = 4.5 V; V _{EE} = 0 V	-	27	63	ns
		$V_{CC} = 5.0 \text{ V}; V_{EE} = 0 \text{ V}; C_L = 15 \text{ pF}$	-	21	-	ns
		V _{CC} = 6.0 V; V _{EE} = 0 V	-	22	54	ns
		$V_{CC} = 4.5 \text{ V}; V_{EE} = -4.5 \text{ V}$	-	22	48	ns
C_{PD}	power dissipation capacitance	per switch; $V_I = GND$ to V_{CC}	<u>[5]</u> _	57	-	pF
T _{amb} = -4	0 °C to +125 °C					
t _{pd}	propagation delay	V_{is} to V_{os} ; $R_L = \infty \Omega$; see Figure 13	[2]			
		V _{CC} = 2.0 V; V _{EE} = 0 V	-	-	90	ns
		$V_{CC} = 4.5 \text{ V}; V_{EE} = 0 \text{ V}$	-	-	18	ns
		V _{CC} = 6.0 V; V _{EE} = 0 V	-	-	15	ns
		$V_{CC} = 4.5 \text{ V}; V_{EE} = -4.5 \text{ V}$	-	-	12	ns
t _{on}	turn-on time	\overline{E} , Sn to V_{os} ; $R_{L} = \infty \ \Omega$; see Figure 14	[3]			
		V _{CC} = 2.0 V; V _{EE} = 0 V	-	-	490	ns
		V _{CC} = 4.5 V; V _{EE} = 0 V	-	-	98	ns
		V _{CC} = 6.0 V; V _{EE} = 0 V	-	-	83	ns
		$V_{CC} = 4.5 \text{ V}; V_{EE} = -4.5 \text{ V}$	-	-	69	ns

Table 9. Dynamic characteristics for 74HC4052-Q100 ...continued

GND = 0 V; $t_r = t_f = 6 \text{ ns}$; $C_L = 50 \text{ pF}$; for test circuit see <u>Figure 15</u>.

V_{is} is the input voltage at a nYn or nZ terminal, whichever is assigned as an input.

Vos is the output voltage at a nYn or nZ terminal, whichever is assigned as an output.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t_{off}	turn-off time	\overline{E} , Sn to V_{os} ; $R_L = 1 \text{ k}\Omega$; see $\underline{Figure 14}$	<u>[4]</u>			
		$V_{CC} = 2.0 \text{ V}; V_{EE} = 0 \text{ V}$	-	-	375	ns
		$V_{CC} = 4.5 \text{ V}; V_{EE} = 0 \text{ V}$	-	-	75	ns
		$V_{CC} = 6.0 \text{ V}; V_{EE} = 0 \text{ V}$	-	-	64	ns
		$V_{CC} = 4.5 \text{ V}; V_{EE} = -4.5 \text{ V}$	-	-	57	ns

- [1] All typical values are measured at $T_{amb} = 25$ °C.
- [2] t_{pd} is the same as t_{PHL} and t_{PLH} .
- [3] t_{on} is the same as t_{PZH and} t_{PZL}.
- [4] t_{off} is the same as t_{PHZ} and t_{PLZ} .
- [5] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma \{ (C_L + C_{sw}) \times V_{CC}^2 \times f_o \} \text{ where: }$

 f_i = input frequency in MHz;

fo = output frequency in MHz;

N = number of inputs switching;

 $\Sigma \{ (C_L + C_{sw}) \times V_{CC}^2 \times f_o \} = sum of outputs;$

C_L = output load capacitance in pF;

 C_{sw} = switch capacitance in pF;

 V_{CC} = supply voltage in V.

Table 10. Dynamic characteristics for 74HCT4052-Q100

GND = 0 V; $t_r = t_f = 6$ ns; $C_L = 50$ pF; for test circuit see Figure 15.

*V*_{is} is the input voltage at a nYn or nZ terminal, whichever is assigned as an input.

Vos is the output voltage at a nYn or nZ terminal, whichever is assigned as an output.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$T_{amb} = -4$	0 °C to +85 °C[1]					
t _{pd}	propagation delay	V_{is} to V_{os} ; $R_L = \infty \Omega$; see <u>Figure 13</u>	<u>[2]</u>			
		V _{CC} = 4.5 V; V _{EE} = 0 V	-	5	15	ns
		$V_{CC} = 4.5 \text{ V}; V_{EE} = -4.5 \text{ V}$	-	4	10	ns
t _{on} turn-on time		\overline{E} , Sn to V_{os} ; $R_L = 1 \text{ k}\Omega$; see Figure 14	<u>[3]</u>			
		V _{CC} = 4.5 V; V _{EE} = 0 V	-	41	88	ns
	$V_{CC} = 5.0 \text{ V}; V_{EE} = 0 \text{ V}; C_L = 15 \text{ pF}$	-	18	-	ns	
		$V_{CC} = 4.5 \text{ V}; V_{EE} = -4.5 \text{ V}$	-	28	60	ns
t _{off}	turn-off time	\overline{E} , Sn to V_{os} ; $R_L = 1 \text{ k}\Omega$; see Figure 14	<u>[4]</u>			
	turn-off time	V _{CC} = 4.5 V; V _{EE} = 0 V	-	26	63	ns
		$V_{CC} = 5.0 \text{ V}; V_{EE} = 0 \text{ V}; C_L = 15 \text{ pF}$	-	13	-	ns
		$V_{CC} = 4.5 \text{ V}; V_{EE} = -4.5 \text{ V}$	-	21	48	ns
C_{PD}	power dissipation capacitance	per switch; $V_I = GND$ to $V_{CC} - 1.5 \text{ V}$	<u>[5]</u> _	57	-	pF

Table 10. Dynamic characteristics for 74HCT4052-Q100 ...continued

 $GND = 0 \text{ V; } t_r = t_f = 6 \text{ ns; } C_L = 50 \text{ pF; for test circuit see } \underline{Figure 15}.$

 V_{is} is the input voltage at a nYn or nZ terminal, whichever is assigned as an input.

 V_{os} is the output voltage at a nYn or nZ terminal, whichever is assigned as an output.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$T_{amb} = -4$	0 °C to +125 °C					
t _{pd}	propagation delay	V_{is} to V_{os} ; $R_L = \infty \Omega$; see Figure 13	[2]			
		V _{CC} = 4.5 V; V _{EE} = 0 V	-	-	18	ns
		$V_{CC} = 4.5 \text{ V}; V_{EE} = -4.5 \text{ V}$	-	-	12	ns
on turn-on time	\overline{E} , Sn to V_{os} ; $R_L = 1 \text{ k}\Omega$; see Figure 14	[3]				
	turn-on time	V _{CC} = 4.5 V; V _{EE} = 0 V	-	-	105	ns
		$V_{CC} = 4.5 \text{ V}; V_{EE} = -4.5 \text{ V}$	-	-	72	ns
t _{off}	turn-off time	\overline{E} , Sn to V_{os} ; $R_L = 1 \text{ k}\Omega$; see Figure 14	<u>[4]</u>			
		V _{CC} = 4.5 V; V _{EE} = 0 V	-	-	75	ns
		$V_{CC} = 4.5 \text{ V}; V_{EE} = -4.5 \text{ V}$	-	-	57	ns

- [1] All typical values are measured at $T_{amb} = 25$ °C.
- [2] t_{pd} is the same as t_{PHL} and t_{PLH} .
- [3] t_{on} is the same as t_{PZH} and t_{PZL} .
- [4] t_{off} is the same as t_{PHZ} and t_{PLZ} .
- [5] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma \{ (C_L + C_{sw}) \times V_{CC}^2 \times f_o \} \text{ where: }$$

 f_i = input frequency in MHz;

fo = output frequency in MHz;

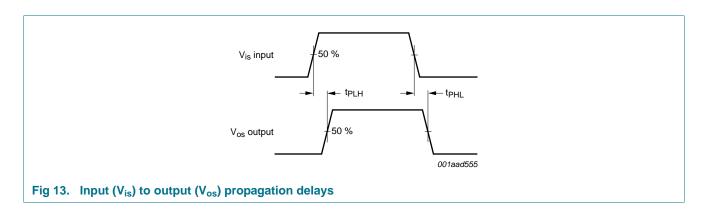
N = number of inputs switching;

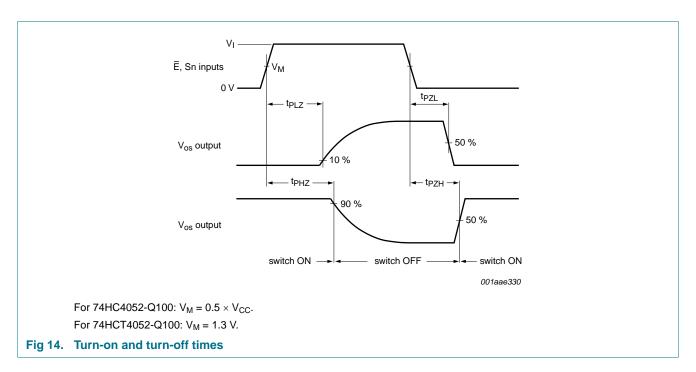
 $\Sigma \{ (C_L + C_{sw}) \times V_{CC}^2 \times f_o \} = \text{sum of outputs};$

C_L = output load capacitance in pF;

C_{sw} = switch capacitance in pF;

 V_{CC} = supply voltage in V.





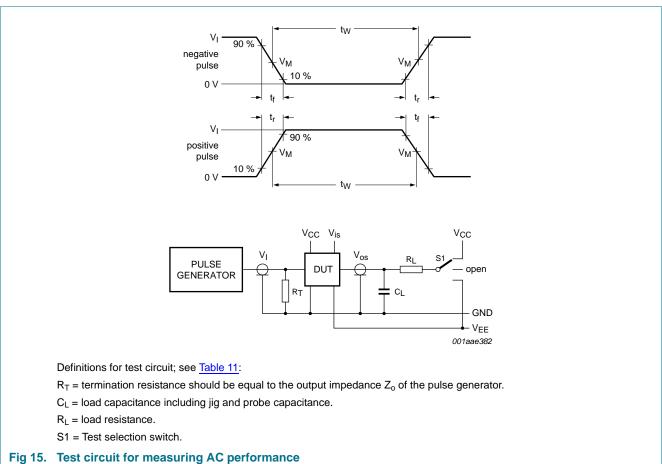


Table 11. Test data

Test	Input			Load		S1 position	
	VI	V _{is}	t _r , t _f	t _r , t _f		R _L	
			at f _{max}	other[1]			
t _{PHL} , t _{PLH}	[2]	pulse	< 2 ns	6 ns	50 pF	1 kΩ	open
t _{PZH} , t _{PHZ}	[2]	V_{CC}	< 2 ns	6 ns	50 pF	1 kΩ	V_{EE}
t _{PZL} , t _{PLZ}	[2]	V_{EE}	< 2 ns	6 ns	50 pF	1 kΩ	V_{CC}

^[1] $t_r = t_f = 6$ ns; when measuring f_{max} , there is no constraint to t_r and t_f with 50 % duty factor.

- a) For 74HC4052-Q100: $V_I = V_{CC}$
- b) For 74HCT4052-Q100: $V_1 = 3 \text{ V}$

12. Additional dynamic characteristics

Table 12. Additional dynamic characteristics

Recommended conditions and typical values; $GND = 0 \ V$; $T_{amb} = 25 \ ^{\circ}C$; $C_L = 50 \ pF$. V_{is} is the input voltage at pins nYn or nZ, whichever is assigned as an input. V_{os} is the output voltage at pins nYn or nZ, whichever is assigned as an output.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
d _{sin}	sine-wave distortion	$f_i = 1 \text{ kHz}$; $R_L = 10 \text{ k}\Omega$; see Figure 16				
		$V_{is} = 4.0 \text{ V (p-p)}; V_{CC} = 2.25 \text{ V}; V_{EE} = -2.25 \text{ V}$	-	0.04	-	%
		$V_{is} = 8.0 \text{ V (p-p)}; V_{CC} = 4.5 \text{ V}; V_{EE} = -4.5 \text{ V}$	-	0.02	-	%
		$f_i = 10 \text{ kHz}$; $R_L = 10 \text{ k}\Omega$; see Figure 16				
		$V_{is} = 4.0 \text{ V (p-p)}; V_{CC} = 2.25 \text{ V}; V_{EE} = -2.25 \text{ V}$	-	0.12	-	%
		$V_{is} = 8.0 \text{ V (p-p)}; V_{CC} = 4.5 \text{ V}; V_{EE} = -4.5 \text{ V}$	-	0.06	-	%
α_{iso}	isolation (OFF-state)	$R_L = 600 \Omega$; $f_i = 1 MHz$; see Figure 17				
	· ,	$V_{CC} = 2.25 \text{ V}; V_{EE} = -2.25 \text{ V}$	[1] -	-50	-	dB
		$V_{CC} = 4.5 \text{ V}; V_{EE} = -4.5 \text{ V}$	[1] -	-50	-	dB
Xtalk crosstalk	crosstalk	between two switches/multiplexers; $R_L = 600 \Omega$; $f_i = 1 MHz$; see Figure 18				
	un Gostan	$V_{CC} = 2.25 \text{ V}; V_{EE} = -2.25 \text{ V}$	<u>[1]</u> -	-60	-	dB
		$V_{CC} = 4.5 \text{ V}; V_{EE} = -4.5 \text{ V}$	<u>[1]</u> _	-60	-	dB
V _{ct} crosstalk voltage		peak-to-peak value between control and any switch. $R_L = 600 \ \Omega$; $f_i = 1 \ MHz$; \overline{E} or Sn square wave between V_{CC} and GND; $t_r = t_f = 6 \ ns$; see Figure 19				
		V _{CC} = 4.5 V; V _{EE} = 0 V	-	110	-	mV
		$V_{CC} = 4.5 \text{ V}; V_{EE} = -4.5 \text{ V}$	-	220	-	mV
f _(-3dB)	-3 dB frequency response	$R_L = 50 \Omega$; see Figure 20				
		$V_{CC} = 2.25 \text{ V}; V_{EE} = -2.25 \text{ V}$	[2] _	170	-	MHz
		$V_{CC} = 4.5 \text{ V}; V_{EE} = -4.5 \text{ V}$	[2]	180	-	MHz

^[1] Adjust input voltage V_{is} to 0 dBm level (0 dBm = 1 mW into 600 Ω).

74HC_HCT4052_Q100

^[2] V_I values:

^[2] Adjust input voltage V_{is} to 0 dBm level at V_{os} for 1 MHz (0 dBm = 1 mW into 50 Ω).

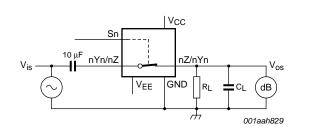
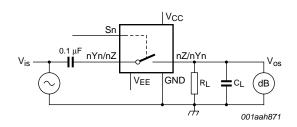
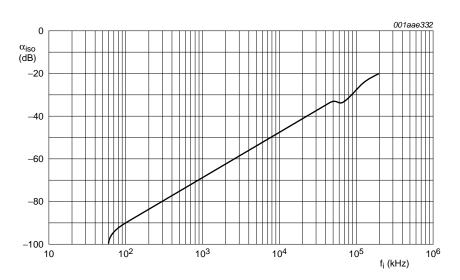


Fig 16. Test circuit for measuring sine-wave distortion



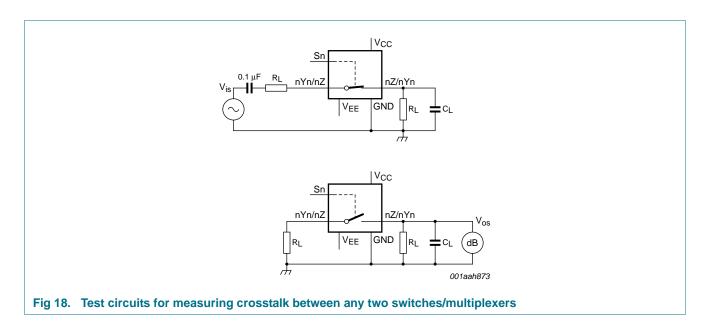
 V_{CC} = 4.5 V; GND = 0 V; V_{EE} = –4.5 V; R_L = 600 $\Omega;$ R_S = 1 k $\Omega.$

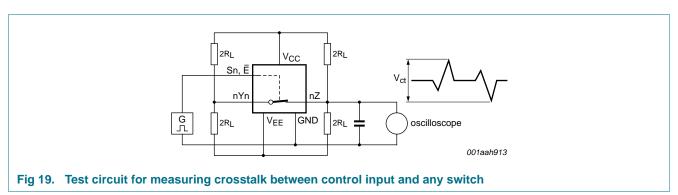
a. Test circuit

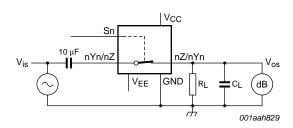


b. Isolation (OFF-state) as a function of frequency

Fig 17. Test circuit for measuring isolation (OFF-state)

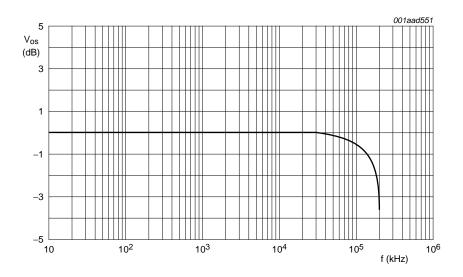






 V_{CC} = 4.5 V; GND = 0 V; V_{EE} = –4.5 V; R_L = 50 $\Omega;$ R_S = 1 $k\Omega.$

a. Test circuit



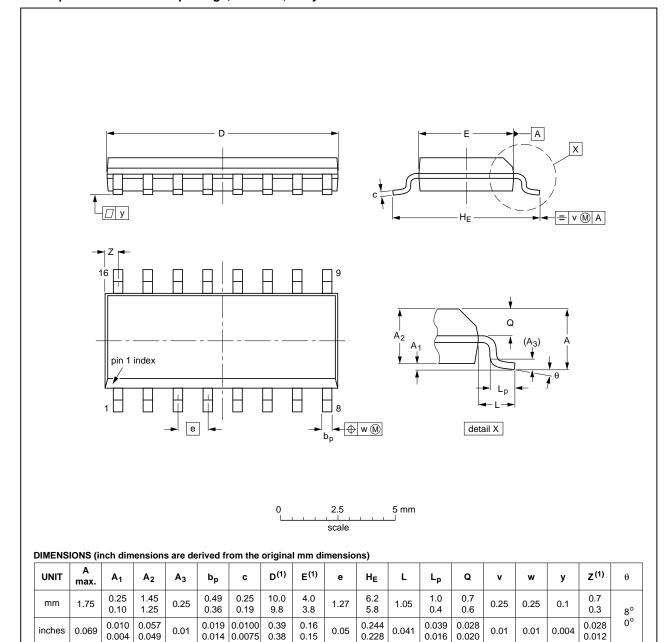
b. Typical frequency response

Fig 20. Test circuit for frequency response

13. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE	
SOT109-1	076E07	MS-012			-99-12-27- 03-02-19	

Fig 21. Package outline SOT109-1 (SO16)

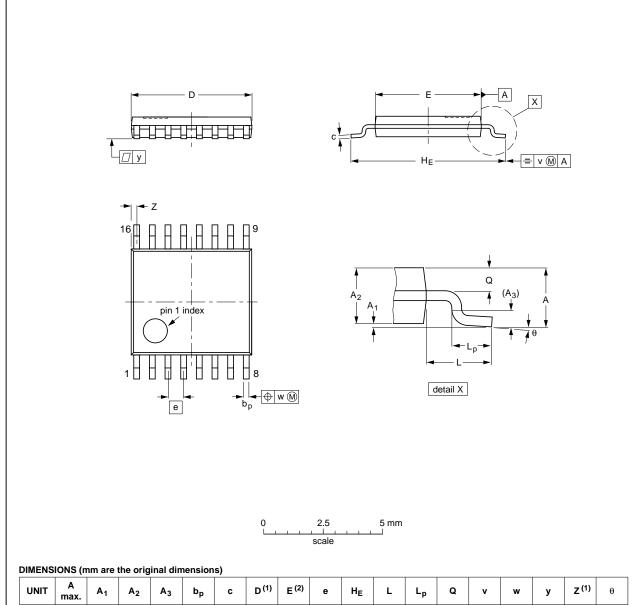
74HC_HCT4052_Q100

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TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



-					,		-,												
	UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E (2)	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
	mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.40 0.06	8° 0°

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

JEITA	PROJECTION	N ISSUE DATE
	I I	
		9 9-12-27 03-02-18

Fig 22. Package outline SOT403-1 (TSSOP16)

74HC_HCT4052_Q100

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DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

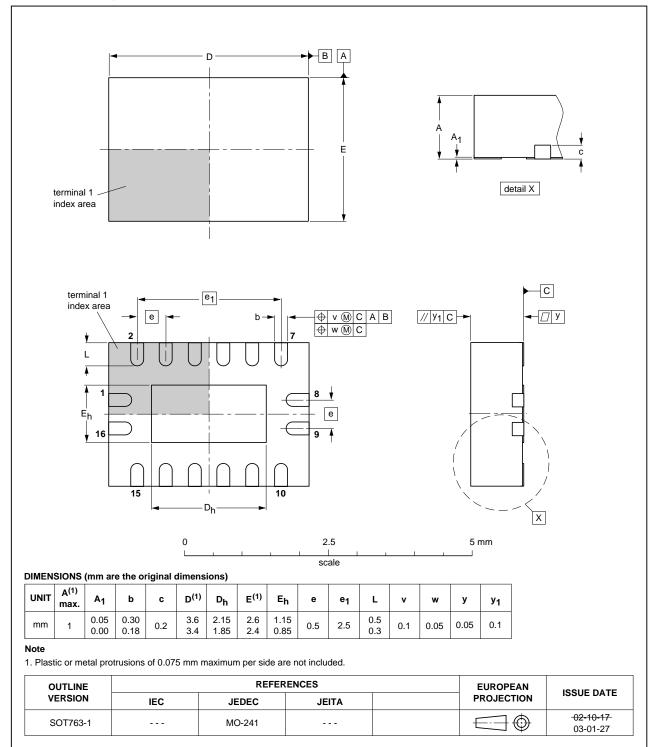


Fig 23. Package outline SOT763-1 (DHVQFN16)

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14. Abbreviations

Table 13. Abbreviations

Acronym	Description
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
MIL	Military

15. Revision history

Table 14. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT4052_Q100 v.2	20121122	Product data sheet	-	74HC_HCT4052_Q100 v.1
Modifications:	 CDM added 	to features.		
74HC_HCT4052_Q100 v.1	20120720	Product data sheet	-	-

16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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74HC_HCT4052_Q100

74HC4052-Q100; 74HCT4052-Q100

Dual 4-channel analog multiplexer/demultiplexer

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Dual 4-channel analog multiplexer/demultiplexer

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